## **VSMB1940ITX01**



**Vishay Semiconductors** 

## High Speed Infrared Emitting Diode, 940 nm, GaAIAs Double Hetero



DESCRIPTION

VSMB1940ITX01 is an infrared, 940 nm emitting diode in GaAlAs double hetero technology with high radiant power and high speed, molded in clear, untinted 0805 plastic package for surface mounting (SMD).

#### FEATURES

- Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- Enhanced operating temperature range: -40 °C to +105 °C
- Peak wavelength:  $\lambda_p = 940 \text{ nm}$
- High reliability
- · High radiant power
- High radiant intensity
- High speed
- Angle of half sensitivity:  $\varphi = \pm 60^{\circ}$
- · Low forward voltage
- Suitable for high pulse current operation
- 0805 standard surface-mountable package
- Floor life: 72 h, MSL 4, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- IR emitter for automotive applications
- · High power emitter for low space applications
- · High performance transmissive or reflective sensors

PRODUCT SUMMARY				
COMPONENT	l <sub>e</sub> (mW/sr)	φ (°)	λ <sub>p</sub> (nm)	t <sub>r</sub> (ns)
VSMB1940ITX01	6	± 60	940	15

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMB1940ITX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

• MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V <sub>R</sub>	5	V	
Forward current		١ <sub>F</sub>	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I <sub>FM</sub>	200	mA	
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1	A	
Power dissipation		Pv	160	mW	
Junction temperature		Тj	110	°C	
Operating temperature range		T <sub>amb</sub>	-40 to +105	°C	
Storage temperature range		T <sub>stg</sub>	-40 to +110	°C	
Soldering temperature	According to reflow profile Fig. 9	T <sub>sd</sub>	260	°C	
Thermal resistance junction / ambient	JESD 51	R <sub>thJA</sub>	270	K/W	

Rev. 1.2, 24-Mar-2025

1 For technical questions, contact: <u>SensorsTechSupport@vishay.com</u> Document Number: 84258

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





ROHS COMPLIANT

HALOGEN

FREE

GREEN (5-2008)



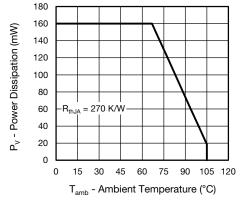


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature



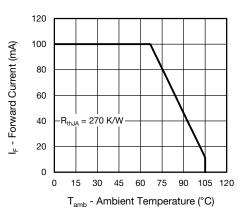


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	V <sub>F</sub>	1.15	1.35	1.6	V
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	V <sub>F</sub>	-	2.2	-	V
Temperature coefficient of $V_{\text{F}}$	I <sub>F</sub> = 1 mA	TK <sub>VF</sub>	-	-1.5	-	mV/K
	I <sub>F</sub> = 100 mA	TK <sub>VF</sub>	-	-1.1	-	mV/K
Reverse current	$V_R = 5 V$	I <sub>R</sub>	-	-	10	μA
Junction capacitance	$V_R = 0 V$ , f = 1 MHz, E = 0 mW/cm <sup>2</sup>	CJ	-	70	-	pF
Radiant intensity	$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	l <sub>e</sub>	3	6	12	mW/sr
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	l <sub>e</sub>	-	60	-	mW/sr
Radiant power	$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	фе	-	40	-	mW
Temperature coefficient of radiant power	I <sub>F</sub> = 1 mA	TKφe	-	-1.1	-	%/K
	I <sub>F</sub> = 100 mA	TKφ <sub>e</sub>	-	-0.51	-	%/K
Angle of half intensity		φ	-	± 60	-	٥
Peak wavelength	I <sub>F</sub> = 30 mA	λρ	-	940	-	nm
Spectral bandwidth	I <sub>F</sub> = 30 mA	Δλ	-	25	-	nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 30 mA	TK <sub>λp</sub>	-	0.25	-	nm
Rise time	$I_F$ = 100 mA, 20 % to 80 %	t <sub>r</sub>	-	15	-	ns
Fall time	$I_F$ = 100 mA, 20 % to 80 %	t <sub>f</sub>	-	15	-	ns
Virtual source diameter		d	-	0.5	-	mm





#### **BASIC CHARACTERISTICS** ( $T_{amb} = 25 \text{ °C}$ , unless otherwise specified)

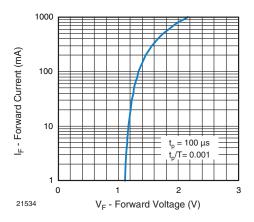


Fig. 3 - Forward Current vs. Forward Voltage

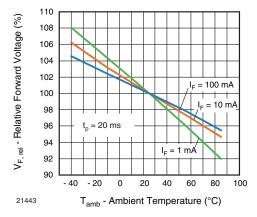


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

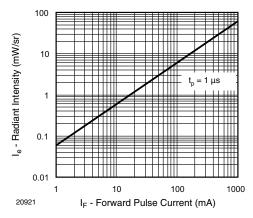


Fig. 5 - Radiant Intensity vs. Forward Current

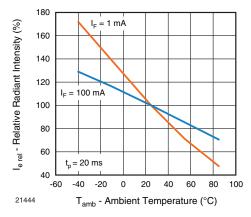


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

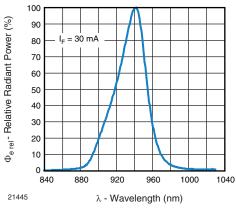


Fig. 7 - Relative Radiant Power vs. Wavelength

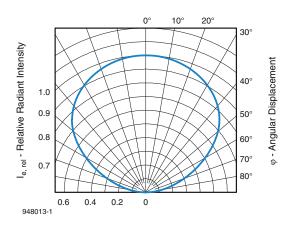


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

Rev. 1.2, 24-Mar-2025

3

Document Number: 84258

For technical questions, contact: <u>SensorsTechSupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



# VISHAY, www.vishay.com

#### **REFLOW SOLDER PROFIEL**

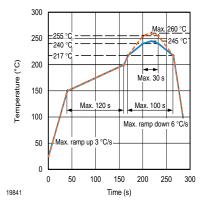


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

#### **PACKAGE DIMENSIONS** in millimeters

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

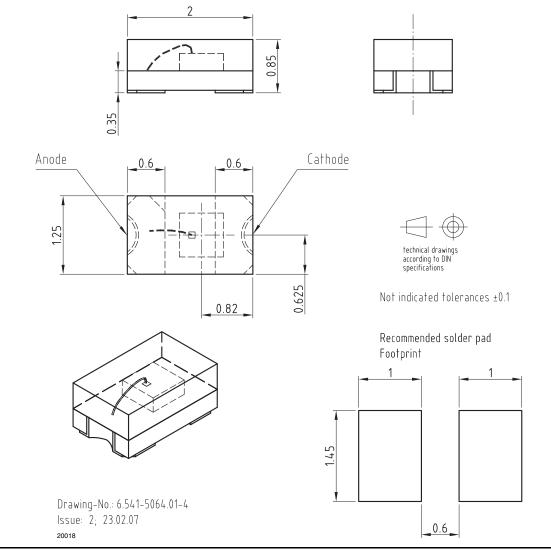
Moisture sensitivity: level 4

Floor life: 72 h

Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

#### DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



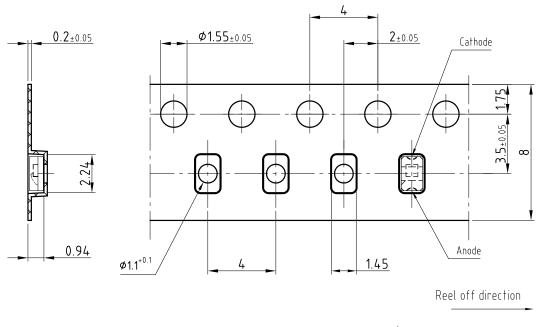
Rev. 1.2, 24-Mar-2025

4 questions contact: SoncersTachSupport Document Number: 84258

For technical questions, contact: <u>SensorsTechSupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



#### **BLISTER TAPE DIMENSIONS** in millimeters



technical drawings according to DIN specifications

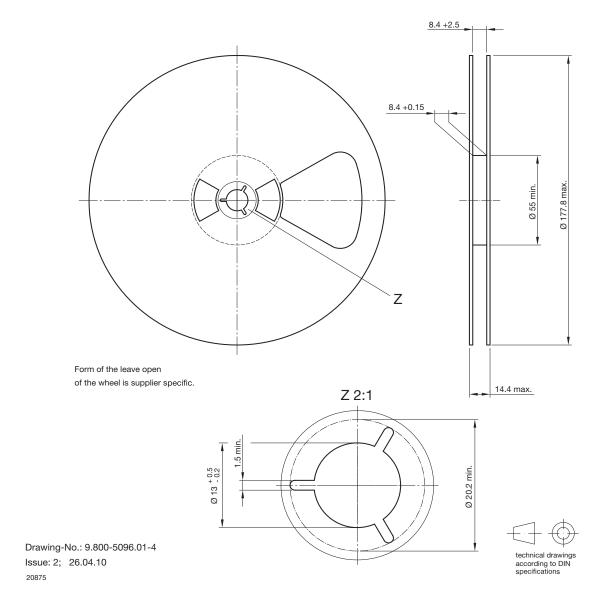
Drawing-No.: 9.700-5311.01-4 Issue: 1; 23.02.07 21501

Not indicated tolerances ±0.1





#### **REEL DIMENSIONS** in millimeters



6



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2025 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2025

1